

Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _F (MAX) (V)	I _R (MAX) (mA)
45	5	0.56	0.2

Description and Applications

The SBR545SAFQ is a 5A 45V single rectifier packaged in the low profile SMAF package. Providing low V_F and excellent high temperature stability this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- Recirculating Diode

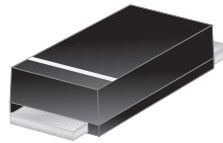
Features

- Patented SBR[®] technology provides an avalanche capability five times larger than Schottky diodes ensuring more rugged and reliable end applications.
- Lower reverse leakage ensuring greater stability at higher temperatures.
- Low forward voltage (V_F) minimizes conduction losses and improving efficiency.
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Mechanical Data

- Case: SMAF
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 **e3**
- Polarity: Cathode Band
- Weight: 0.035 grams (Approximate)

SMAF

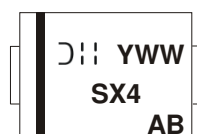


Top View

Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
SBR545SAFQ-13	Automotive	SMAF	10000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to <https://www.diodes.com/quality/>.
 5. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information


SX4 = Product Type Marking Code
 J;: = Manufacturers' Code Marking
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: G for 2019)
 WW = Week Code (01 to 53)
 AB = Foundry and Assembly Code

Year	2013	2014	2015	2016	2017	2018	2019	2020
Code	A	B	C	D	E	F	G	H

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	45	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _{RM}		
Average Rectified Output Current (See Figure 1)	I _O	5.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	100	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Case (Note 6)	R _{θJC}	20	°C/W
Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	45	
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	0.5	0.56	V	I _F = 5.0A, T _J = +25°C
		—	0.485	—	V	I _F = 5.0A, T _J = +125°C
Leakage Current (Note 7)	I _R	—	0.04	0.2	mA	V _R = 45V, T _J = +25°C
		—	6	43	mA	V _R = 45V, T _J = +125°C

Notes: 6. Device mounted on FR-4 substrate, 1" x 1", 2oz, single-sided, PC boards with 0.56" x 0.73" copper pad.
7. Short duration pulse test used to minimize self-heating effect.

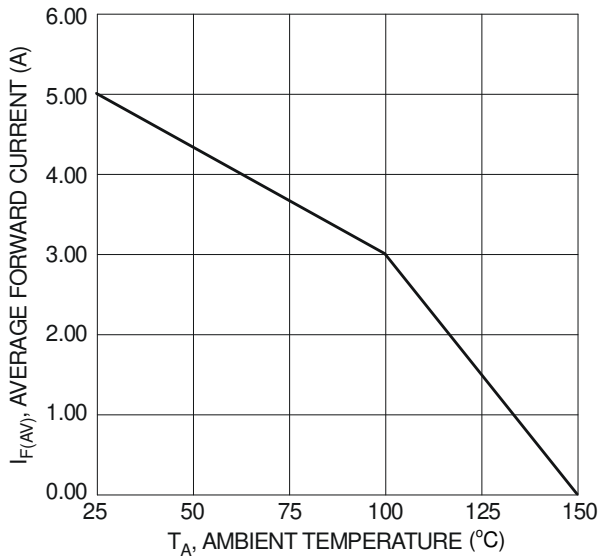


Figure 1 Forward Current Derating Curve

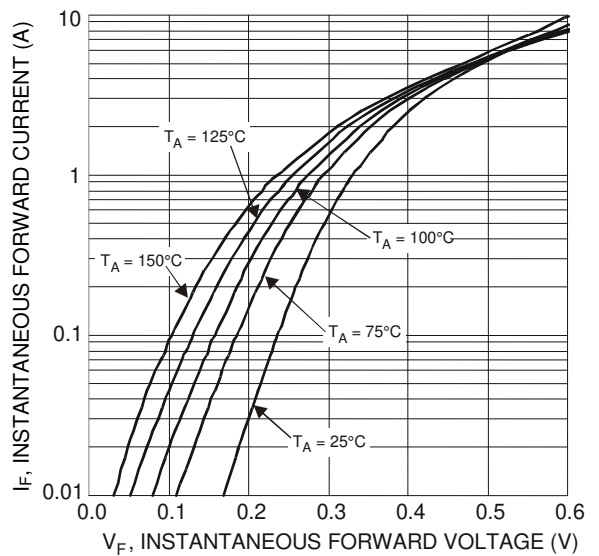


Figure 2 Typical Forward Characteristics

NEW PRODUCT

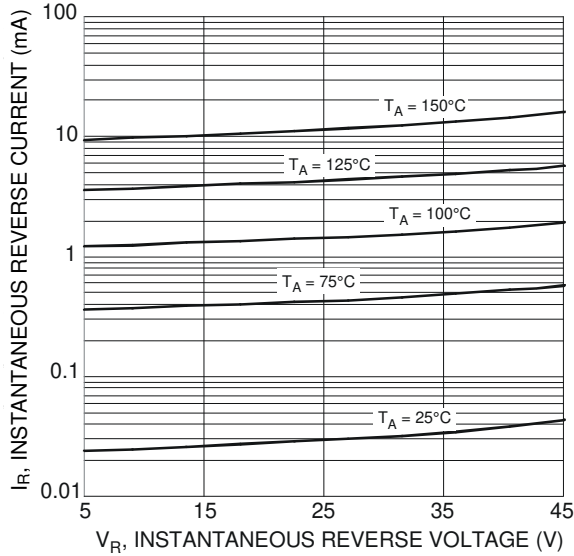


Figure 3 Typical Reverse Characteristics

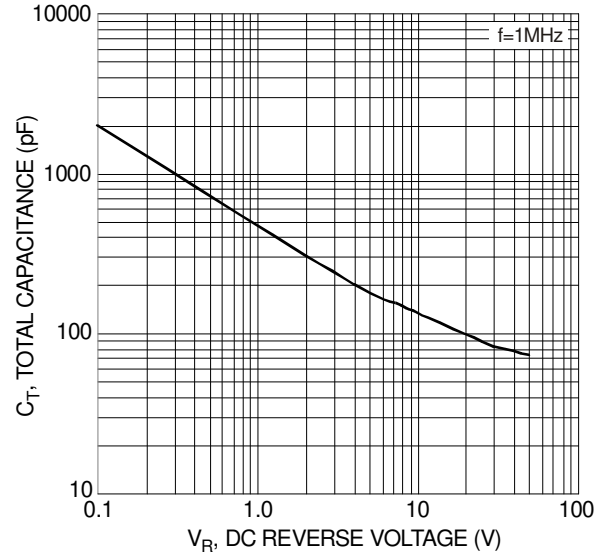
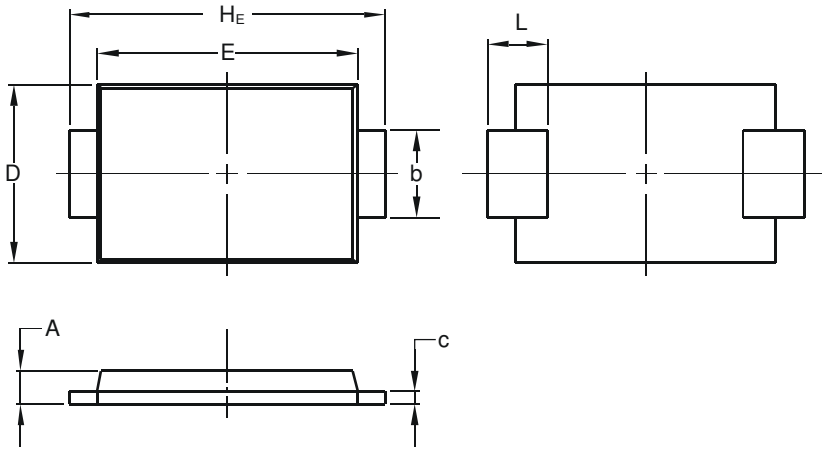


Figure 4 Total Capacitance vs. Reverse Voltage

Package Outline Dimensions

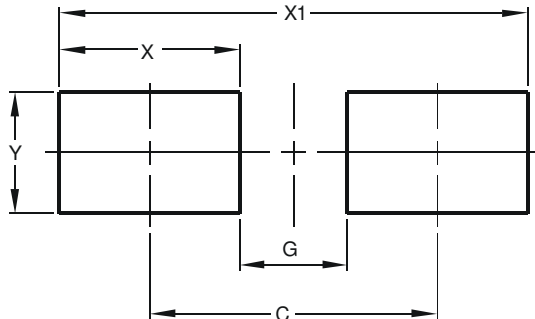
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



SMAF		
Dim	Min	Max
A	0.90	1.10
b	1.25	1.65
c	0.10	0.40
D	2.25	2.95
E	3.95	4.60
H _E	4.80	5.60
L	0.50	1.50
All Dimensions in mm		

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

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